



IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF:

:

Juen-Kuen LIN, et al.

: EXAMINER:

SERIAL NO: New Application

FILED: Herewith

: GROUP ART UNIT:

FOR: WAFER POLISHING HEAD

PRELIMINARY AMENDMENT

ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

SIR:

Prior to an examination on the merits, please amend the above-identified patent application as follows:

IN THE SPECIFICATION

Page 4, line 5, change "controlled" to --controller--.

Page 6, line 16, change "wafer 60" to --wafer 66--.

IN THE CLAIMS

Please cancel Claims 2, 3 and 8-10 without prejudice.